

SANYO Semiconductors DATA SHEET

LB11862M — Single-Phase Full-Wave Fan Motor Driver

Overview

The LB11862M is optimal for small fan applications, especially CPU cooling fans, due to its single-phase full-wave drive technique and the compact package.

Low switching noise and effective motor drive are further advantages.

Features

- •Support for 5V/12V dual power supply voltage.
- •Built-in regenerative circuit allows use of reverse-connection protection diode.
- •Built-in Hall amplifier with hysteresis (supports core without commutating pole).
- •Built-in lockup protection and automatic recovery circuits.
- •Latch-type lockup detection output (RD) is low during rotation and high during stop.
- •Hall bias pin and start/stop pin allow reduced current drain in standby mode.
- •Built-in thermal protection circuit.

Specifications

Absolute Maximum Ratings at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	V _{CC} max		17	V
Maximum output current	I _{OUT} max		0.8	Α
Maximum output withstand voltage	V _{OUT} max		17	V
RD maximum output withstand voltage	V _R max		17	V
RD maximum output current	I _R max		5	mA
HB maximum output current	I _B max		10	mA
ST maximum input voltage	V _{ST} max		15	V
Allowable power dissipation	Pd max	Mounted on the specified board*	800	mW
Operating temperature	Topr		-40 to +85	°C
Storage temperature	Tstg		-55 to +150	°C

^{*}Specified board : $114.3 \times 76.2 \times 1.5$ mm, glass epoxy.

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Allowable Operating Range at Ta = 25°C

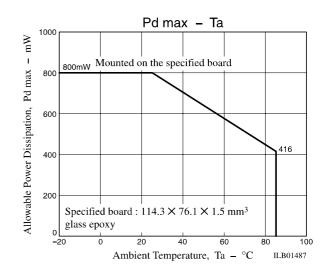
Parameter	Symbol	Conditions	Ratings	Unit	
Supply voltage	Vcc		3.8 to 16.8	V	
ST input high-level voltage	STH		3 to 14	V	
ST input low-level voltage	STL		-0.3 to 0.4	V	
Hall input common-mode input voltage range	VICM		0.2 to V _{CC} -1.5	V	

Electrical Characteristics at Ta = 25 °C, $V_{CC} = 5V$, unless otherwise specified.

Doggoode	O. made ad	Constitution -	Ratings			11.7
Parameter	Symbol	Conditions	min	typ	max	Unit
		Operating mode (CT = L, ST = L)		12	17	mA
Circuit current	Icc	Lock protecting mode (CT = H, ST = L)		2.5	4.0	mA
		Standby mode (ST = H)		110	150	μΑ
Lock detection capacitor charging current	ICT1	VCT = 0.2 V	1.5	2.1	3.0	μА
Capacitor discharging current	ICT2	VCT = 3.0 V	0.21	0.35	0.50	μΑ
Capacitor charging/discharging current ratio	RCT	RCD = ICT1/ICT2	5.0	6.0	8.0	-
CT charging voltage	VCT1		2.55	2.75	2.95	V
CT discharging voltage	VCT2		1.6	1.8	2.0	V
Output low-level voltage	V _{OL}	I _O = 200 mA		0.2	0.3	V
Output high-level voltage	Voн	I _O = 200 mA	3.9	4.1		V
Hall input sensitivity	VHN	Zero peak value. (Including offset, hysteresis)		7	15	mV
RD output pin low-level voltage	VRD	IRD = 5 mA		0.1	0.3	V
RD output pin leakage current	IRDL	VRD = 15 V			30	μΑ
HB output low-level voltage	VHBL	IHB = 5 mA		1.0	1.3	V
ST pin input current	IST	VST = 5 V		75	100	μΑ

Package Dimensions

unit : mm

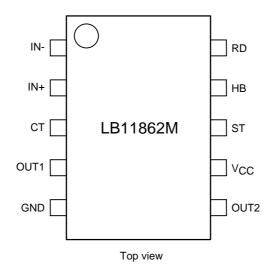


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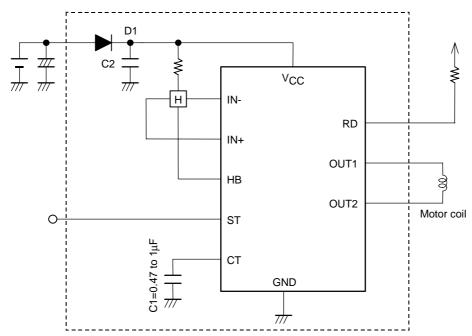
ST	IN-	IN+	СТ	OUT1	OUT2	RD	НВ	Mode
Н	-	-	-	off	off	off	off	Standby
	Н	L	L	Н	L		L	On anating a
L	L	Н		L	Н			Operating
			Н	off	off	off	L	Lock protection

(The RD output is latched at "L"-level in operating mode and "H"-level in stop mode.)

Pin Assignment

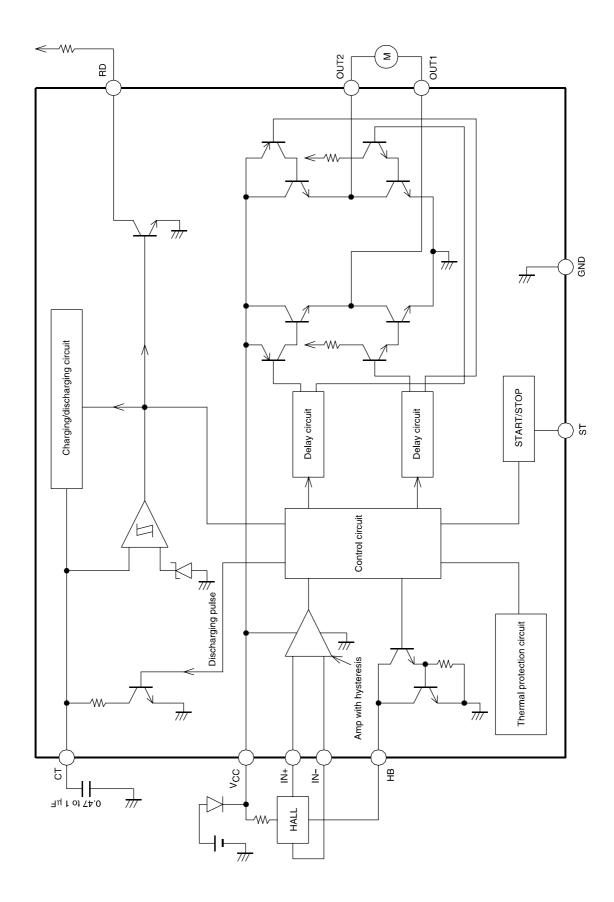


Sample Application Circuit



- (1) D1 is used to prevent IC destruction caused by reverse-connection. It can be omitted if no problems are expected.
- (2) C2 is used to apply a kickback regenerative current when using the IC with the coil current over 500 mA.
- (3) When CT is not used, it should be connected to ground.
- (4) When RD, ST, and HB are not used, they should be left open.

Block Diagram



LB11862M

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